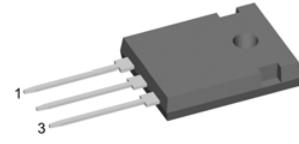
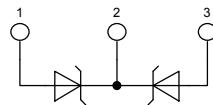


Schottky Diode Gen 2

High Performance Schottky Diode
Low Loss and Soft Recovery
Common Cathode

Part number**DSB 80 C 45 HB**

Backside: cathode

Features / Advantages:

- Very low V_f
- Extremely low switching losses
- low I_{rm} values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Package:

- Housing: TO-247
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

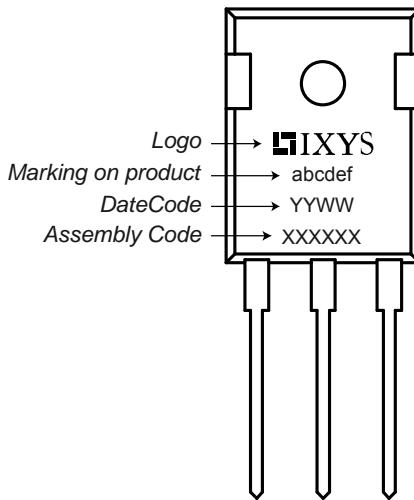
Symbol	Definition	Conditions		Ratings		
				min.	typ.	max.
V _{RRM}	max. repetitive reverse voltage		T _{VJ} = 25°C			45 V
I _R	reverse current	V _R = 45V	T _{VJ} = 25°C		15 mA	
		V _R = 45V	T _{VJ} = 100°C		150 mA	
V _F	forward voltage	I _F = 40A	T _{VJ} = 25°C		0.62 V	
		I _F = 80A			0.90 V	
		I _F = 40A	T _{VJ} = 125°C		0.59 V	
		I _F = 80A			0.88 V	
I _{FAV}	average forward current	rectangular d = 0.5	T _C = 120°C		40 A	
V _{F0} r _F	threshold voltage slope resistance } for power loss calculation only		T _{VJ} = 150°C		0.31 V	
					7 mΩ	
R _{thJC}	thermal resistance junction to case				0.70 K/W	
T _{VJ}	virtual junction temperature			-55	150 °C	
P _{tot}	total power dissipation		T _C = 25°C		180 W	
I _{FSM}	max. forward surge current	t = 10 ms (50 Hz), sine	T _{VJ} = 45°C		600 A	
C _J	junction capacitance	V _R = 5V; f = 1 MHz	T _{VJ} = 25°C		1.38 nF	
E _{AS}	non-repetitive avalanche energy	I _{AS} = 26 A; L = 180 μH	T _{VJ} = 25°C		61 mJ	
I _{AR}	repetitive avalanche current	V _A = 1.5·V _R typ.: f = 10 kHz			2.6 A	

Symbol	Definition	Conditions	Ratings		
			min.	typ.	max.
I_{RMS}	RMS current	per pin ¹⁾			50
R_{thCH}	thermal resistance case to heatsink			0.25	K/W
T_{stg}	storage temperature		-55		150
Weight				6	g
M_D	mounting torque		0.8		1.2
F_c	mounting force with clip		20		120
					N

¹⁾ I_{RMS} is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.

In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

Product Marking

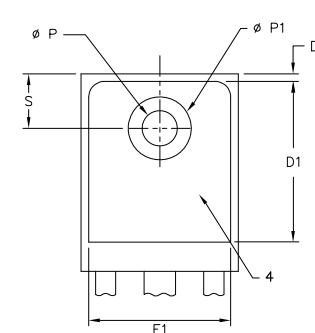
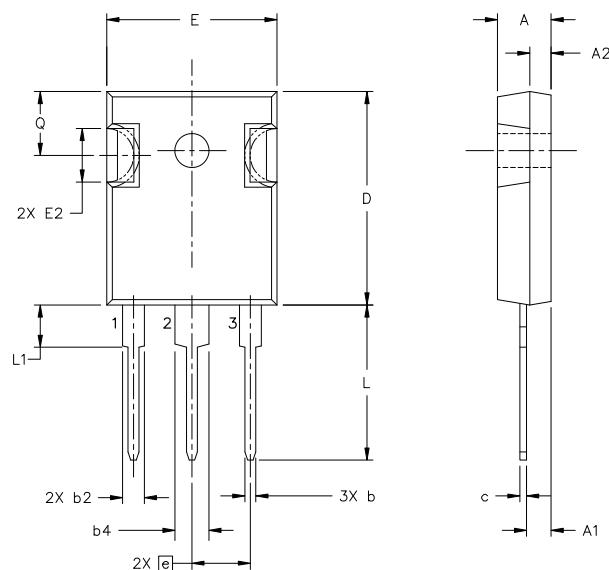


Part number

D = Diode
 S = Schottky Diode
 B = ultra low VF
 80 = Current Rating [A]
 C = Common Cathode
 45 = Reverse Voltage [V]
 HB = TO-247AD (3)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DSB 80 C 45 HB	DSB80C45HB	Tube	30	504883

Outlines TO-247



Symbol	Inches min	Inches max	Millimeters min	Millimeters max
A	0.185	0.209	4.70	5.30
A1	0.087	0.102	2.21	2.59
A2	0.059	0.098	1.50	2.49
D	0.819	0.845	20.79	21.45
E	0.610	0.640	15.48	16.24
E2	0.170	0.216	4.31	5.48
e	0.215 BSC		5.46 BSC	
L	0.780	0.800	19.80	20.30
L1	-	0.177	-	4.49
ØP	0.140	0.144	3.55	3.65
ØP1	0.212	0.244	5.38	6.19
S	0.242 BSC		6.14 BSC	
b	0.039	0.055	0.99	1.40
b2	0.065	0.094	1.65	2.39
b4	0.102	0.135	2.59	3.43
c	0.015	0.035	0.38	0.89
D1	0.515	-	13.07	-
D2	0.020	0.053	0.51	1.35
E1	0.530	-	13.45	-
ØP1	-	0.291	-	7.39